

## FST3383 10-Bit Low Power Bus Exchange Switch

### General Description

The FST3383 provides two sets of high-speed CMOS TTL-compatible bus switches. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. The device operates as a 10-bit bus switch or a 5-bit bus exchanger. The bus exchange (BX) signal provides nibble swapping of the AB and CD pairs of signals. This exchange configuration allows byte swapping of buses in systems. It can also be used as a quad 2-to-1 multiplexer and to create low delay barrel shifters. The bus enable ( $\overline{OE}$ ) signal turns the switches ON.

### Features

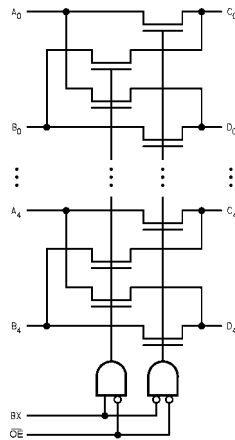
- $5\Omega$  switch connection between two ports
- Zero propagation delay
- Ultra low power with  $0.2\ \mu\text{A}$  typical  $I_{CC}$
- Zero ground bounce in flow-through mode
- Control inputs compatible with TTL level

### Ordering Code:

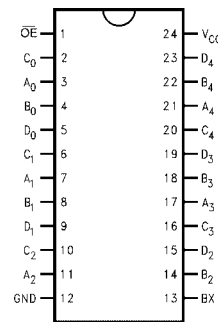
Order Number	Package Number	Package Description
FST3383WM	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
FST3383QSC	MQA24	24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 Wide
FST3383MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### Logic Diagram



### Connection Diagram



### Pin Descriptions

Pin Names	Description
$\overline{OE}$	Bus Switch Enable
BX	Bus Exchange
$A_0$ - $A_4$ , $B_0$ - $B_4$	Buses A, B
$C_0$ - $C_4$ , $D_0$ - $D_4$	Buses C, D

### Truth Table

$\overline{OE}$	BX	$A_0$ - $A_4$	$B_0$ - $B_4$	Function
H	X	High-Z State	High-Z State	Disconnect
L	L	$C_0$ - $C_4$	$D_0$ - $D_4$	Connect
L	H	$D_0$ - $D_4$	$C_0$ - $C_4$	Exchange

**Absolute Maximum Ratings**(Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Switch Voltage ( $V_S$ )	-0.5V to +7.0V
DC Input Voltage ( $V_I$ ) (Note 2)	-0.5V to +7.0V
DC Input Diode Current ( $I_{IN}$ ) with $V_I < 0$	-20 mA
DC Output ( $I_O$ ) Sink Current	120 mA
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150°C
Power Dissipation	0.5W

**Recommended Operating Conditions**

Supply Voltage ( $V_{CC}$ )	4.0V to 5.5V
Free Air Operating Temperature ( $T_A$ )	-40°C to +85°C

**Note 1:** The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 2:** The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

**DC Electrical Characteristics**

Symbol	Parameter	$V_{CC}$ (V)	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$			Units	Conditions
			Min	Typ (Note 3)	Max		
$V_{IK}$	Maximum Clamp Diode Voltage	4.75			-1.2	V	$I_{IN} = -18 \text{ mA}$
$V_{IH}$	Minimum High Level Input Voltage	4.75-5.25	2.0			V	
$V_{IL}$	Maximum Low Level Input Voltage	4.75-5.25			0.8	V	
$I_{IN}$	Maximum Input Leakage Current	0			10	$\mu\text{A}$	$0 \leq V_{IN} \leq 5.25\text{V}$
		5.25			$\pm 1$		
$I_{OZ}$	Maximum 3-STATE I/O Leakage	5.25			$\pm 10$	$\mu\text{A}$	$0 \leq A, B \leq V_{CC}$
$I_{OS}$	Short Circuit Current	4.75	100			mA	$V_I(A), V_I(B) = 0\text{V}, V_I(B), V_I(A) = 4.75\text{V}$
$R_{ON}$	Switch On Resistance (Note 4)	4.75		5	7	$\Omega$	$V_I = 0\text{V}, I_{ON} = 30 \text{ mA}$
				10	15		
$I_{CC}$	Maximum Quiescent Supply Current	5.25		0.2	10	$\mu\text{A}$	$V_I = V_{CC}, \text{GND}, I_O = 0$
$\Delta I_{CC}$	Increase in $I_{CC}$ per Input (Note 5)	5.25			2.5	mA	$V_{IN} = 3.15\text{V}, I_O = 0, \text{Per Control Input}$

**Note 3:** All typical values are at  $V_{CC} = 5.0\text{V}, T_A = 25^\circ\text{C}$ .

**Note 4:** Measured by voltage drop between A and B pin at indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

**Note 5:** Per TTL driven input ( $V_{IN} = 3.15\text{V}$ , control inputs only). A and B pins do not contribute to  $I_{CC}$ .

## AC Electrical Characteristics

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C, C <sub>L</sub> = 50 pF			Units
			Min	Typ (Note 6)	Max	
t <sub>PLH</sub> , t <sub>PHL</sub>	Data Propagation Delay A <sub>n</sub> to C <sub>n</sub> , D <sub>n</sub> or B <sub>n</sub> to D <sub>n</sub> , C <sub>n</sub> (Note 7)	4.75			0.25	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Switch Exchange Time BX to A <sub>n</sub> , B <sub>n</sub> , C <sub>n</sub> , D <sub>n</sub>	4.75	1.5		6.5	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Switch Enable Time B $\bar{E}$ to A <sub>n</sub> , B <sub>n</sub> , C <sub>n</sub> or D <sub>n</sub>	4.75	1.5		6.5	ns
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Switch Disable Time B $\bar{E}$ to A <sub>n</sub> , B <sub>n</sub> , C <sub>n</sub> , or D <sub>n</sub>	4.75	1.5		5.5	ns

**Note 6:** All typical values are at V<sub>CC</sub> = 5.0V, T<sub>A</sub> = 25°C.

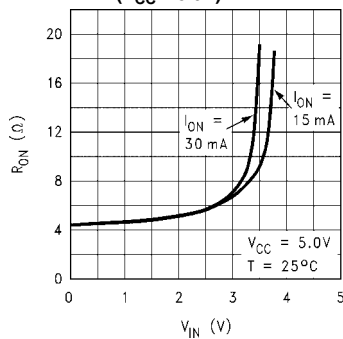
**Note 7:** This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On resistance of the switch and the load capacitance. The time constant for the switch and alone is of the order of 0.25 ns for 50 pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

### Capacitance (Note 8)

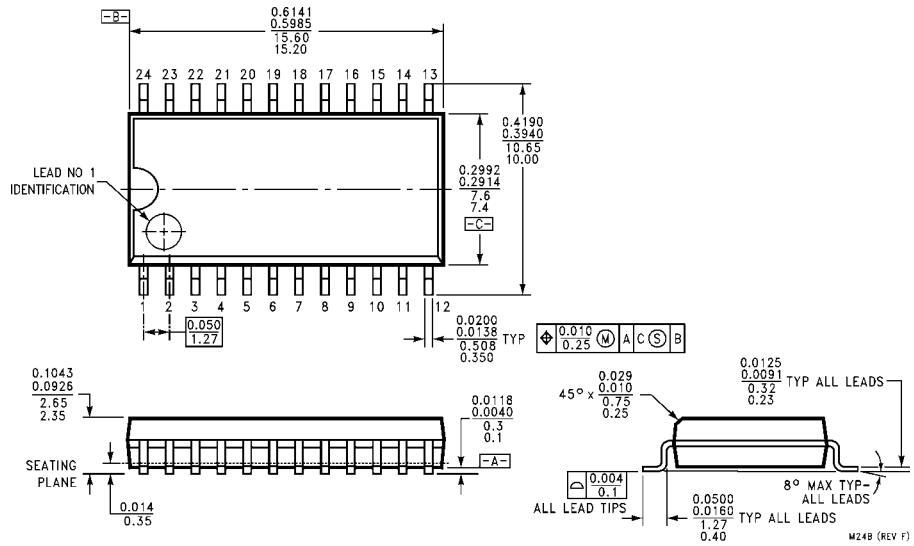
Symbol	Parameter	Typ	Max	Units	Conditions
C <sub>IN</sub>	Control Input Capacitance	4	6	pF	V <sub>CC</sub> = 5.0V
C <sub>I/O</sub> (OFF)	Input/Output Capacitance	9	13	pF	V <sub>CC</sub> = 5.0V

**Note 8:** Capacitance is characterized but not tested.

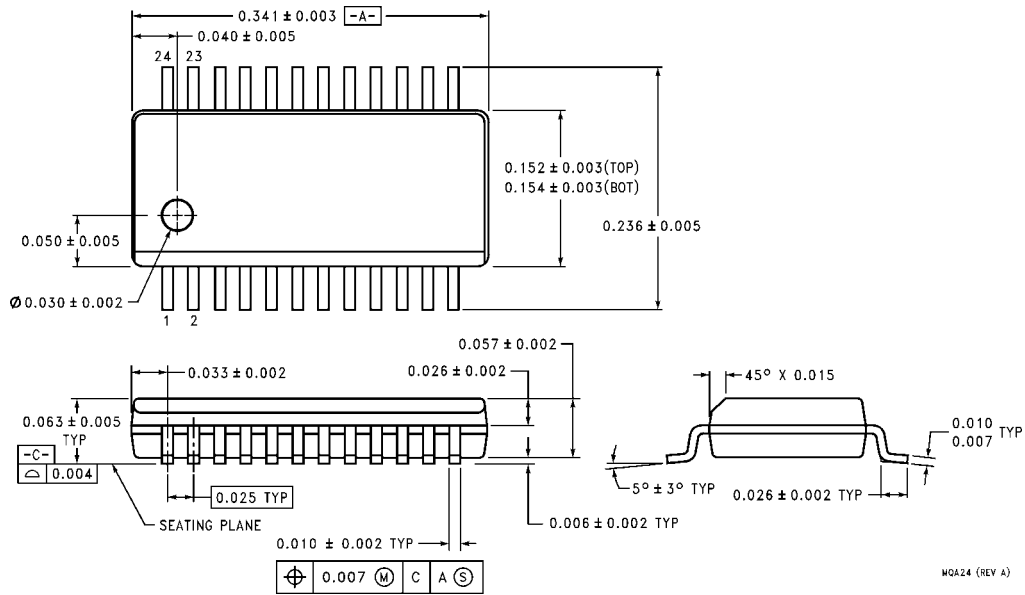
**On-Resistance (R<sub>ON</sub>) vs Input Voltage  
(V<sub>CC</sub> = 5.0V)**



**Physical Dimensions** inches (millimeters) unless otherwise noted

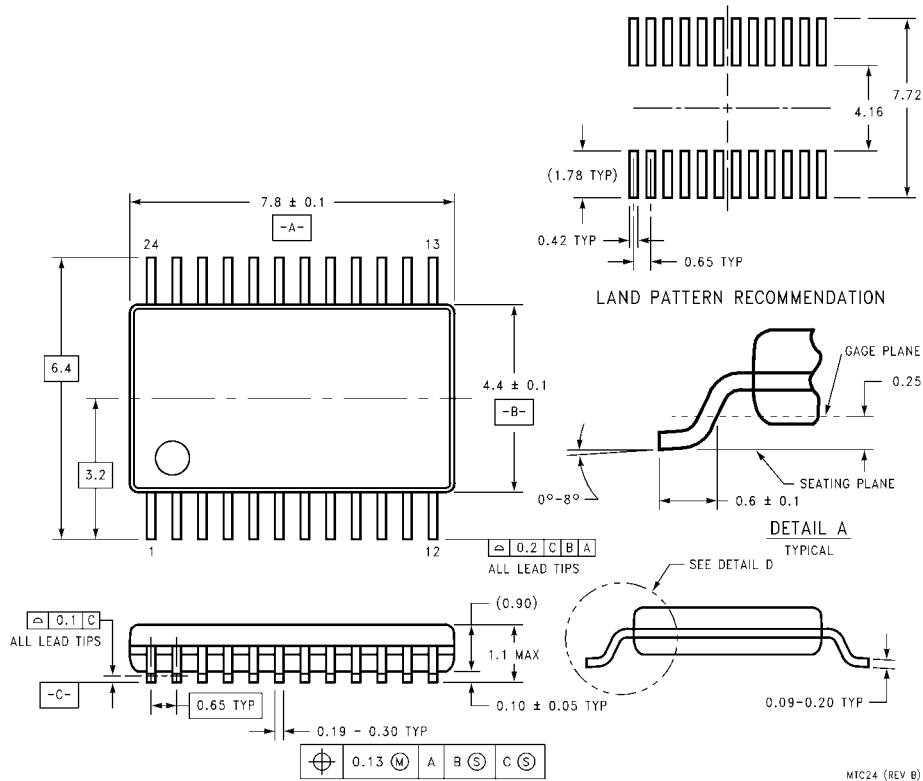


**24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide Package Number M24B**



**24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 Wide Package Number MQA24**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide  
Package Number MTC24**

**Technology Description**

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384 (FST3384) bus switch product.

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